

PATENT ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Jin Woo HAN	04/03/2013
RECEIVING PARTY DATA	
Name:	MAGNACHIP SEMICONDUCTOR, LTD.
Street Address:	1 Hyangjeong-dong, Heungdeok-gu, Cheongju-si, Chungcheongbuk-do, 361-728
City:	Cheongju-si
State/Country:	KOREA, REPUBLIC OF
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	13875941
CORRESPONDENCE DATA	
Fax Number:	
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
Phone:	202-429-0020
Email:	info@nsiplaw.com
Correspondent Name:	NSIP LAW
Address Line 1:	P.O. Box 65745
Address Line 4:	Washington, DISTRICT OF COLUMBIA 20035
ATTORNEY DOCKET NUMBER:	023103.0080
NAME OF SUBMITTER:	S. Laura Chung
Signature:	/S. Laura Chung/
Date:	05/02/2013
Total Attachments: 2 source=NewApp_0231030080_AssignmentExecuted#page1.tif source=NewApp_0231030080_AssignmentExecuted#page2.tif	

OP \$40.00 13875941

PATENT

ASSIGNMENT

For valuable consideration, we,

Jin Woo HAN

103-901, 86-4, Seongju-ro, Sosa-gu, Bucheon-si,
Gyeonggi-do, 422-715, Republic of Korea

hereby assign to:

MAGNACHIP SEMICONDUCTOR, LTD., a Korean corporation having

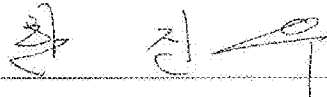
principal executive office(s) or place of business at:

1 Hyangjeong-dong, Heungdeok-gu, Cheongju-si,
Chungcheongbuk-do, 361-728 Republic of Korea; and

its successors and assigns (collectively hereinafter called "the Assignee"), the entire right, title and interest throughout the world in the inventions and improvements which are subject of U.S. Patent Application Number 13/875,941 filed May 02, 2013 at the U.S. Patent & Trademark Office signed by us, with title **SEMICONDUCTOR DEVICE AND FABRICATING METHOD**, and we authorize and request the attorneys appointed in said application to hereafter complete this assignment by inserting above the filing date and application serial number of said application when known; this Assignment including said application, any and all United States and foreign patents, utility models, and design registrations granted for any of said inventions or improvements, and the right to claim priority based on the filing date of said application under the International Convention for the Protection of Industrial Property, the Patent Cooperation Treaty, the European Patent Convention, and all other treaties of like purposes; and we authorize the Assignee to apply in all countries in our name or in its own name for patents, utility models, design registrations and like rights of exclusion and for inventors' certificates for said inventions and improvements; and we agree for ourselves and our respective heirs, legal representatives and assigns, without further compensation to perform such lawful acts and to sign such further applications, assignments, preliminary statements and other lawful documents as the Assignee may reasonably request to effectuate fully this Assignment.

IN TESTIMONY/WITNESS WHEREOF, we, undersigned inventors (Assignors) intending to be legally bound, have hereto affixed our signatures.

This 3 day of April, 2013


Signature: Jin Woo HAN